

74LVC16374A; 74LVCH16374A

16-bit edge-triggered D-type flip-flop; 5 V tolerant; 3-state

Rev. 8 — 21 June 2011

Product data sheet

1. General description

The 74LVC16374A and 74LVCH16374A are 16-bit edge-triggered flip-flops featuring separate D-type inputs with bus hold (74LVCH16374A only) for each flip-flop and 3-state outputs for bus oriented applications. It consists of two sections of eight positive edge-triggered flip-flops. A clock input (\overline{nCP}) and an output enable (\overline{nOE}) are provided for each octal.

The flip-flops will store the state of their individual D-inputs that meet the set-up and hold time requirements on the LOW-to-HIGH clock (CP) transition.

When pin \overline{nOE} is LOW, the contents of the flip-flops are available at the outputs. When pin \overline{nOE} is HIGH, the outputs go to the high-impedance OFF-state. Operation of input \overline{nOE} does not affect the state of the flip-flops.

Inputs can be driven from either 3.3 V or 5 V devices. When disabled, up to 5.5 V can be applied to the outputs. These features allow the use of these devices in mixed 3.3 V and 5 V applications.

Bus hold on data inputs eliminates the need for external pull-up resistors to hold unused inputs.

2. Features and benefits

- 5 V tolerant inputs/outputs for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- Multibyte flow-through standard pin-out architecture
- Low inductance multiple supply pins for minimum noise and ground bounce
- Direct interface with TTL levels
- All data inputs have bus hold (74LVCH16374A only)
- High-impedance outputs when $V_{CC} = 0$ V
- Complies with JEDEC standard JESD8-B/JESD36
- ESD protection:
 - ◆ HBM JESD22-A114F exceeds 2000 V
 - ◆ CDM JESD22-C101D exceeds 1000 V
- Specified from -40 °C to $+85$ °C and -40 °C to $+125$ °C

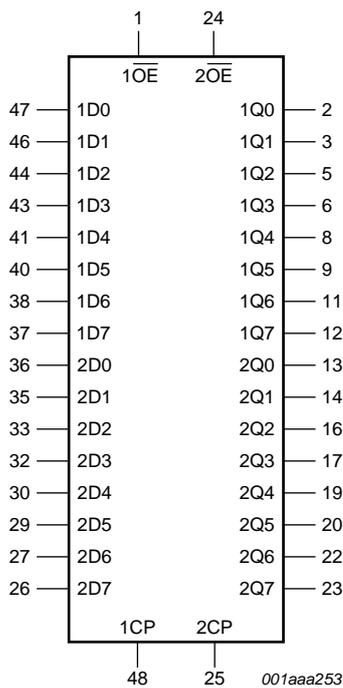


3. Ordering information

Table 1. Ordering information

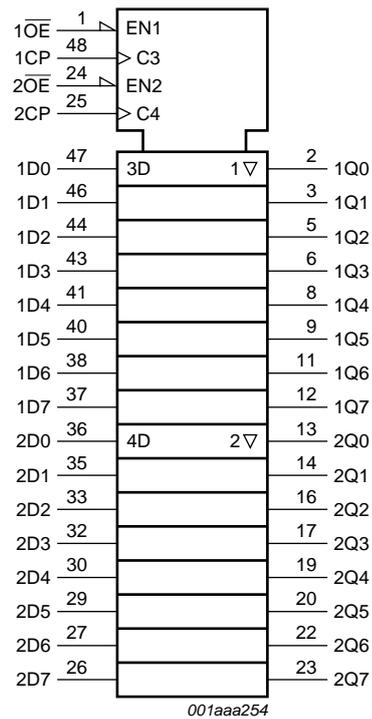
| Type number | Package | | | Version |
|-----------------------------------|-------------------|----------|--|-----------|
| | Temperature range | Name | Description | |
| 74LVC16374ADL 74LVCH16374ADL | -40 °C to +125 °C | SSOP48 | plastic shrink small outline package; 48 leads; body width 7.5 mm | SOT370-1 |
| 74LVC16374ADGG 74LVCH16374ADGG | -40 °C to +125 °C | TSSOP48 | plastic thin shrink small outline package; 48 leads; body width 6.1 mm | SOT362-1 |
| 74LVC16374ABX 74LVCH16374ABX | -40 °C to +125 °C | HXQFN60U | plastic thermal enhanced extremely thin quad flat package; no leads; 60 terminals; UTLP based; body 4 x 6 x 0.5 mm | SOT1134-1 |

4. Functional diagram



Pin numbers are shown for SSOP48 and TSSOP48 packages only.

Fig 1. Logic symbol



Pin numbers are shown for SSOP48 and TSSOP48 packages only.

Fig 2. IEC logic symbol

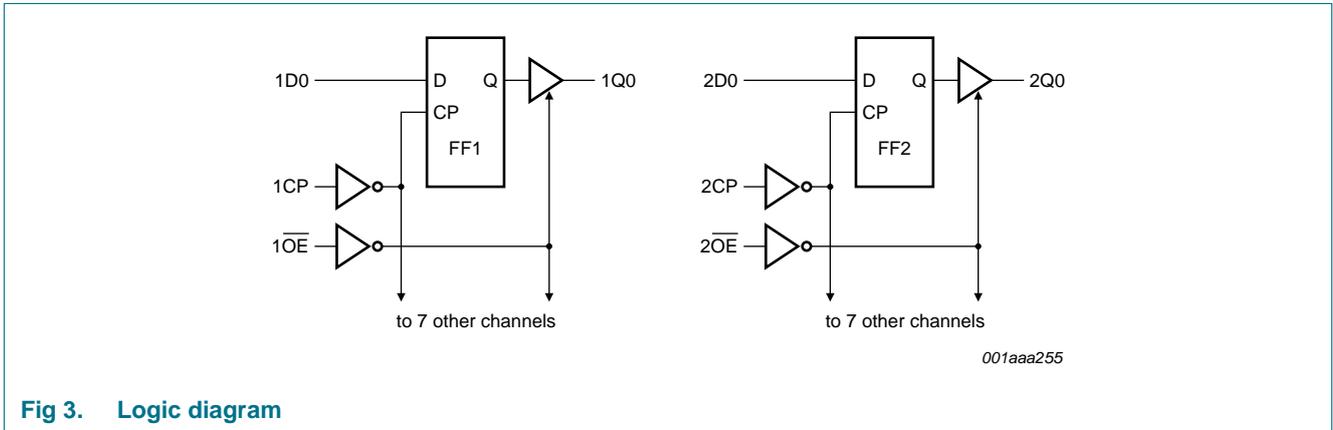


Fig 3. Logic diagram

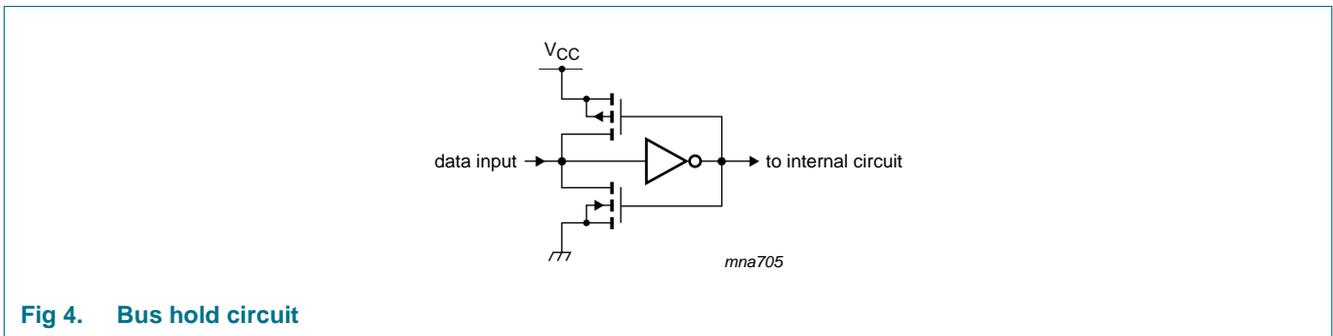
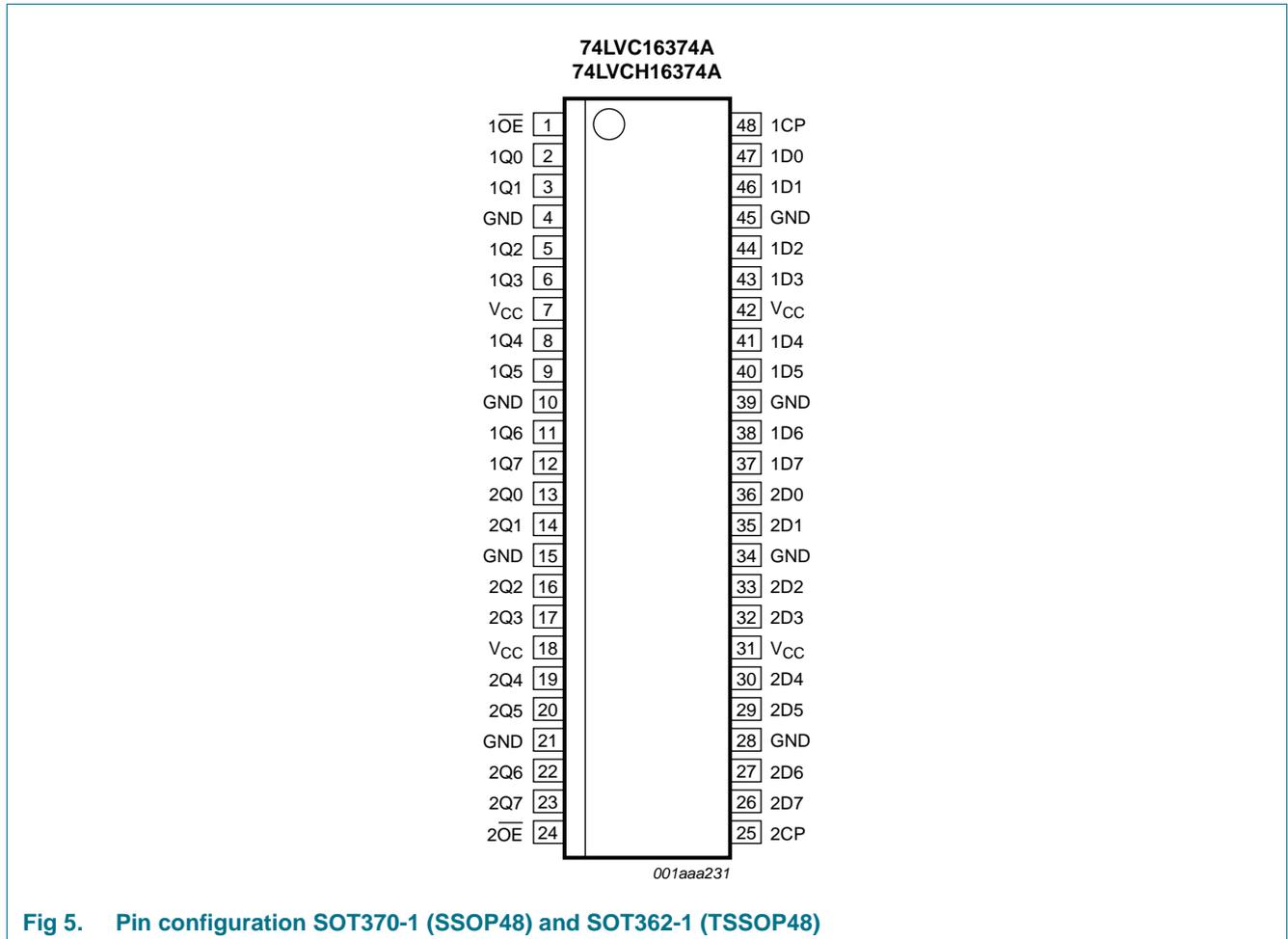
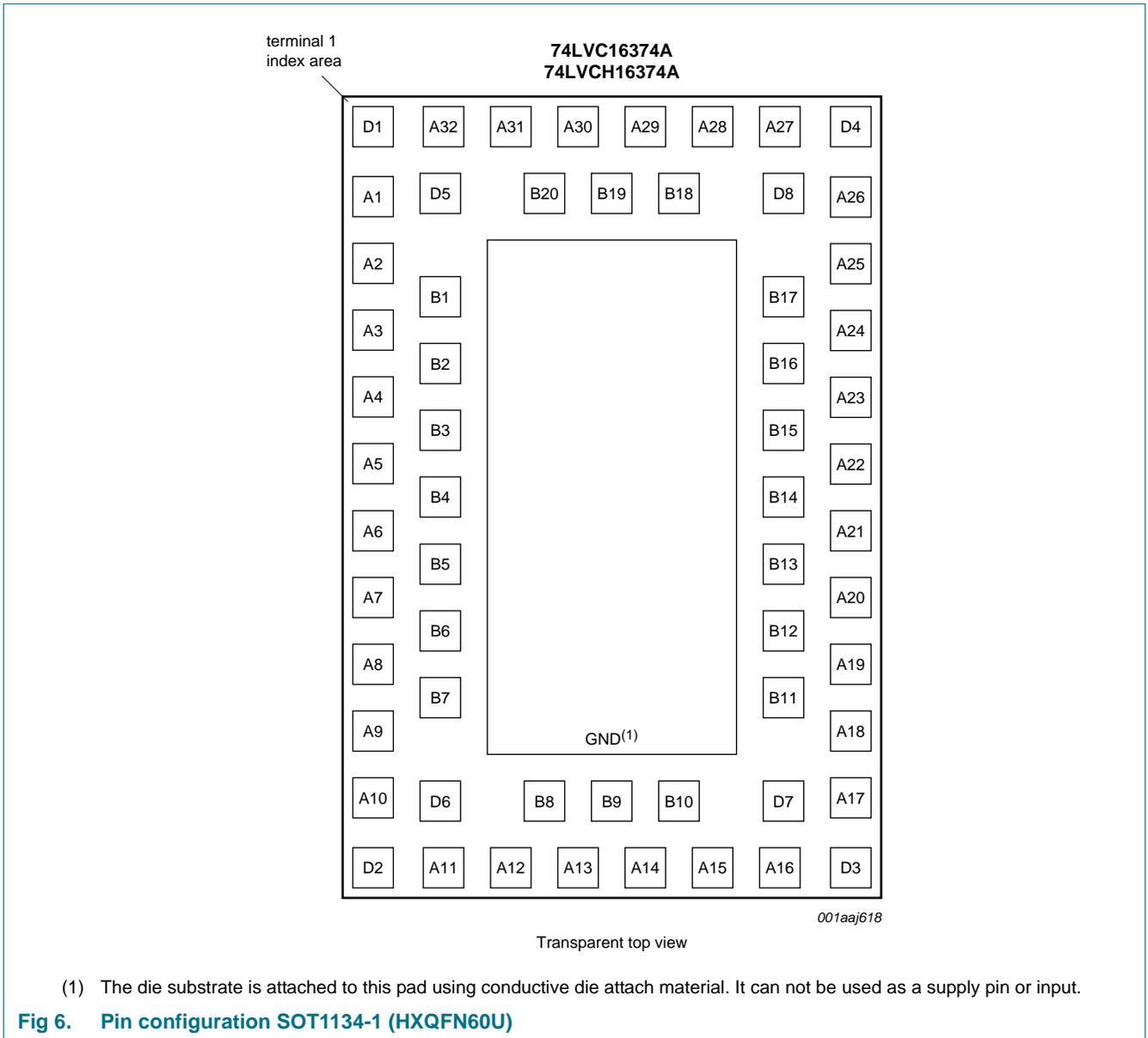


Fig 4. Bus hold circuit

5. Pinning information

5.1 Pinning





5.2 Pin description

Table 2. Pin description

| Symbol | Pin | | Description |
|----------------------------------|--------------------------------|--------------------------------------|----------------------------------|
| | SOT370-1 and SOT362-1 | SOT1134-1 | |
| $\overline{1OE}, \overline{2OE}$ | 1, 24 | A30, A13 | output enable input (active LOW) |
| GND | 4, 10, 15, 21, 28, 34, 39, 45 | A32, A3, A8, A11, A16, A19, A24, A27 | ground (0 V) |
| V _{CC} | 7, 18, 31, 42 | A1, A10, A17, A26 | supply voltage |
| 1Q0 to 1Q7 | 2, 3, 5, 6, 8, 9, 11, 12 | B20, A31, D5, D1, A2, B2, B3, A5 | data output |
| 2Q0 to 2Q7 | 13, 14, 16, 17, 19, 20, 22, 23 | A6, B5, B6, A9, D2, D6, A12, B8 | data output |
| 1D0 to 1D7 | 47, 46, 44, 43, 41, 40, 38, 37 | B18, A28, D8, D4, A25, B16, B15, A22 | data input |
| 2D0 to 2D7 | 36, 35, 33, 32, 30, 29, 27, 26 | A21, B13, B12, A18, D3, D7, A15, B10 | data input |
| 1CP, 2CP | 48, 25 | A29, A14 | clock input |

6. Functional description

Table 3. Function selection^[1]

| Operating mode | Input | | | Internal flip-flop | Output nQ0 to nQ7 |
|-----------------------------------|------------------|-----|-----|--------------------|-------------------|
| | \overline{nOE} | nCP | nDn | | |
| Load and read register | L | ↑ | l | L | L |
| | L | ↑ | h | H | H |
| Load register and disable outputs | H | ↑ | l | L | Z |
| | H | ↑ | h | H | Z |

- [1] H = HIGH voltage level;
h = HIGH voltage level one set-up time prior to the HIGH-to-LOW CP transition;
L = LOW voltage level;
l = LOW voltage level one set-up time prior to the HIGH-to-LOW CP transition;
↑ = LOW-to-HIGH transition;
Z = high-impedance OFF-state.

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|-------------------------|--|---------------------|-----------------------|------|
| V _{CC} | supply voltage | | -0.5 | +6.5 | V |
| I _{IK} | input clamping current | V _I < 0 V | -50 | - | mA |
| V _I | input voltage | | ^[1] -0.5 | +6.5 | V |
| I _{OK} | output clamping current | V _O > V _{CC} or V _O < 0 V | - | ±50 | mA |
| V _O | output voltage | output HIGH-or LOW-state | ^[2] -0.5 | V _{CC} + 0.5 | V |
| | | output 3-state | ^[2] -0.5 | +6.5 | V |
| I _O | output current | V _O = 0 V to V _{CC} | - | ±50 | mA |
| I _{CC} | supply current | | - | 100 | mA |
| I _{GND} | ground current | | -100 | - | mA |
| T _{stg} | storage temperature | | -65 | +150 | °C |

Table 4. Limiting values ...continued

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|-------------------------|--------------------------------------|-------|------|------|
| P _{tot} | total power dissipation | T _{amb} = -40 °C to +125 °C | | | |
| | | (T)SSOP48 package | [3] - | 500 | mW |
| | | HXQFN60U package | [4] - | 1000 | mW |

- [1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.
- [2] The output voltage ratings may be exceeded if the output current ratings are observed.
- [3] Above 60 °C the value of P_{tot} derates linearly with 5.5 mW/K.
- [4] Above 70 °C the value of P_{tot} derates linearly with 1.8 mW/K.

8. Recommended operating conditions

Table 5. Recommended operating conditions

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|------------------|-------------------------------------|--|------|-----|-----------------|------|
| V _{CC} | supply voltage | | 1.65 | - | 3.6 | V |
| | | functional | 1.2 | - | - | V |
| V _I | input voltage | | 0 | - | 5.5 | V |
| V _O | output voltage | active mode | 0 | - | V _{CC} | V |
| | | power-down mode; V _{CC} = 0 V | 0 | - | 5.5 | V |
| T _{amb} | ambient temperature | | -40 | - | +125 | °C |
| Δt/ΔV | input transition rise and fall rate | V _{CC} = 1.65 V to 2.7 V | 0 | - | 20 | ns/V |
| | | V _{CC} = 2.7 V to 3.6 V | 0 | - | 10 | ns/V |

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | -40 °C to +85 °C | | | -40 °C to +125 °C | | Unit |
|-----------------|---------------------------|--|-----------------------|--------------------|-----|------------------------|-----|------|
| | | | Min | Typ ^[1] | Max | Min | Max | |
| V _{IH} | HIGH-level input voltage | V _{CC} = 1.2 V | V _{CC} | - | - | V _{CC} | - | V |
| | | V _{CC} = 2.7 V to 3.6 V | 2.0 | - | - | 2.0 | - | V |
| V _{IL} | LOW-level input voltage | V _{CC} = 1.2 V | - | - | GND | - | GND | V |
| | | V _{CC} = 2.7 V to 3.6 V | - | - | 0.8 | - | 0.8 | V |
| V _{OH} | HIGH-level output voltage | V _I = V _{IH} or V _{IL} | | | | | | |
| | | I _O = -100 μA; V _{CC} = 2.7 V to 3.6 V | V _{CC} - 0.2 | - | - | V _{CC} - 0.3 | - | V |
| | | I _O = -12 mA; V _{CC} = 2.7 V | V _{CC} - 0.5 | - | - | V _{CC} - 0.65 | - | V |
| | | I _O = -18 mA; V _{CC} = 3.0 V | V _{CC} - 0.6 | - | - | V _{CC} - 0.75 | - | V |
| | | I _O = -24 mA; V _{CC} = 3.0 V | V _{CC} - 0.8 | - | - | V _{CC} - 1.0 | - | V |

Table 6. Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | -40 °C to +85 °C | | | -40 °C to +125 °C | | Unit | |
|-------------------|---------------------------------|---|------------------|--------------------|------|-------------------|------|------|----|
| | | | Min | Typ ^[1] | Max | Min | Max | | |
| V _{OL} | LOW-level output voltage | V _I = V _{IH} or V _{IL} I _O = 100 μA; V _{CC} = 2.7 V to 3.6 V | - | - | 0.2 | - | 0.3 | V | |
| | | I _O = 12 mA; V _{CC} = 2.7 V | - | - | 0.4 | - | 0.6 | V | |
| | | I _O = 24 mA; V _{CC} = 3.0 V | - | - | 0.55 | - | 0.8 | V | |
| I _I | input leakage current | V _{CC} = 3.6 V; V _I = 5.5 V or GND | [2] | - | ±0.1 | ±5 | - | ±20 | μA |
| I _{OZ} | OFF-state output current | V _I = V _{IH} or V _{IL} ; V _{CC} = 3.6 V; V _O = 5.5 V or GND; | [2] | - | ±0.1 | ±5 | - | ±20 | μA |
| I _{OFF} | power-off leakage current | V _{CC} = 0 V; V _I or V _O = 5.5 V | - | ±0.1 | ±10 | - | ±20 | μA | |
| I _{CC} | supply current | V _{CC} = 3.6 V; V _I = V _{CC} or GND; I _O = 0 A | - | 0.1 | 20 | - | 80 | μA | |
| ΔI _{CC} | additional supply current | per input pin; V _{CC} = 2.7 V to 3.6 V; V _I = V _{CC} - 0.6 V; I _O = 0 A | [3] | - | 5 | 500 | - | 5000 | μA |
| C _I | input capacitance | V _{CC} = 0 V to 3.6 V; V _I = GND to V _{CC} | - | 5.0 | - | - | - | pF | |
| I _{BHL} | bus hold LOW current | V _{CC} = 3.0 V; V _I = 0.8 V | [4][5] | 75 | - | - | 60 | - | μA |
| I _{BHH} | bus hold HIGH current | V _{CC} = 3.0 V; V _I = 2.0 V | [4][5] | -75 | - | - | -60 | - | μA |
| I _{BHLO} | bus hold LOW overdrive current | V _{CC} = 3.6 V | [4][6] | 500 | - | - | 500 | - | μA |
| I _{BHHO} | bus hold HIGH overdrive current | V _{CC} = 3.6 V | [4][6] | -500 | - | - | -500 | - | μA |

[1] All typical values are measured at V_{CC} = 3.3 V and T_{amb} = 25 °C.

[2] The bus hold circuit is switched off when V_I > V_{CC} allowing 5.5 V on the input pin.

[3] For non bus hold parts only (74LVC16374A).

[4] Valid for data inputs only. Control inputs do not have a bus hold circuit.

[5] The specified sustaining current at the data input holds the input below the specified V_I level.

[6] The specified overdrive current at the data input forces the data input to the opposite logic input state.

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see [Figure 10](#).

| Symbol | Parameter | Conditions | -40 °C to +85 °C | | | -40 °C to +125 °C | | Unit |
|--------------------|-------------------|---|------------------|--------------------|-----|-------------------|-----|------|
| | | | Min | Typ ^[1] | Max | Min | Max | |
| t _{pd} | propagation delay | nCP to nQn; see Figure 7 ^[2] | | | | | | |
| | | V _{CC} = 1.2 V | - | 14 | - | - | - | ns |
| | | V _{CC} = 2.7 V | 1.5 | - | 6.0 | 1.5 | 7.5 | ns |
| | | V _{CC} = 3.0 V to 3.6 V | 1.5 | 3.4 | 5.4 | 1.5 | 7.0 | ns |
| t _{en} | enable time | nOE to nQn; see Figure 9 ^[2] | | | | | | |
| | | V _{CC} = 1.2 V | - | 20 | - | - | - | ns |
| | | V _{CC} = 2.7 V | 1.5 | - | 6.0 | 1.5 | 7.5 | ns |
| | | V _{CC} = 3.0 V to 3.6 V | 1.0 | 3.5 | 5.2 | 1.0 | 6.5 | ns |
| t _{dis} | disable time | nOE to nQn; see Figure 7 ^[2] | | | | | | |
| | | V _{CC} = 1.2 V | - | 12 | - | - | - | ns |
| | | V _{CC} = 2.7 V | 1.5 | - | 5.1 | 1.5 | 6.5 | ns |
| | | V _{CC} = 3.0 V to 3.6 V | 1.5 | 3.9 | 4.9 | 1.5 | 6.5 | ns |
| t _w | pulse width | nCP HIGH; see Figure 7 | | | | | | |
| | | V _{CC} = 1.2 V | - | - | - | - | - | ns |
| | | V _{CC} = 2.7 V | 3.0 | - | - | 3.0 | - | ns |
| | | V _{CC} = 3.0 V to 3.6 V | 3.0 | 1.5 | - | 3.0 | - | ns |
| t _{su} | set-up time | nDn to nCP; see Figure 8 | | | | | | |
| | | V _{CC} = 1.2 V | - | - | - | - | - | ns |
| | | V _{CC} = 2.7 V | 1.9 | - | - | 1.9 | - | ns |
| | | V _{CC} = 3.0 V to 3.6 V | 1.9 | 0.3 | - | 1.9 | - | ns |
| t _h | hold time | nDn to nCP; see Figure 8 | | | | | | |
| | | V _{CC} = 1.2 V | - | - | - | - | - | ns |
| | | V _{CC} = 2.7 V | 1.1 | - | - | 1.1 | - | ns |
| | | V _{CC} = 3.0 V to 3.6 V | 1.5 | -0.3 | - | 1.5 | - | ns |
| f _{max} | maximum frequency | see Figure 7 | | | | | | |
| | | V _{CC} = 2.7 V | 80 | - | - | 80 | - | MHz |
| | | V _{CC} = 3.0 V to 3.6 V | 100 | 150 | - | 100 | - | MHz |
| t _{sk(o)} | output skew time | V _{CC} = 3.0 V to 3.6 V ^[3] | - | - | 1.0 | - | 1.5 | ns |

[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.2 V, 2.7 V, and 3.3 V respectively.

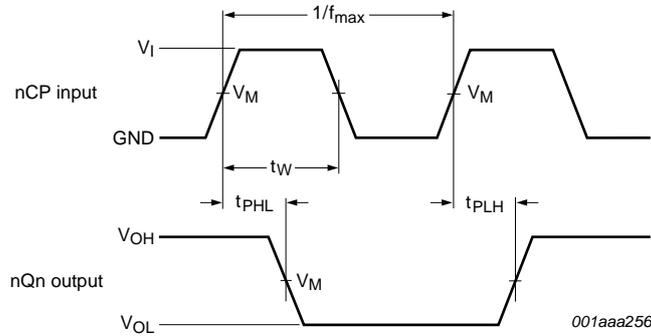
[2] t_{pd} is the same as t_{PLH} and t_{PHL}.

t_{en} is the same as t_{PZL} and t_{PZH}.

t_{dis} is the same as t_{PLZ} and t_{PHZ}.

[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

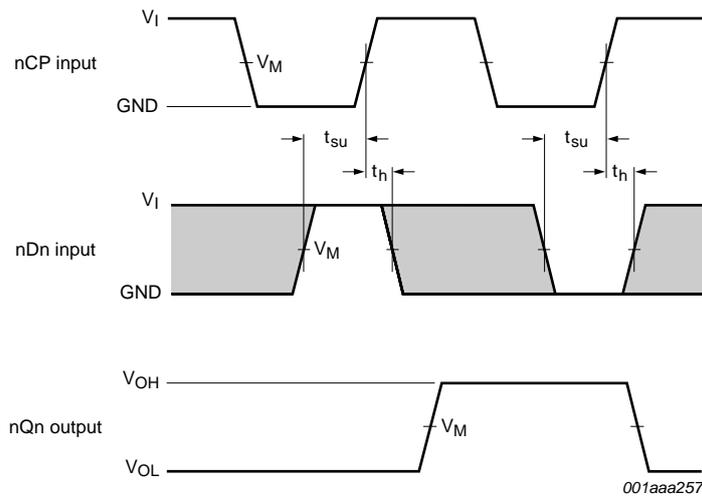
11. Waveforms



Measurement points are given in [Table 8](#).

V_{OL} and V_{OH} are the typical output voltage levels that occur with the output load.

Fig 7. Clock (nCP) to output (nQn) propagation delays, clock pulse width, and the maximum frequency

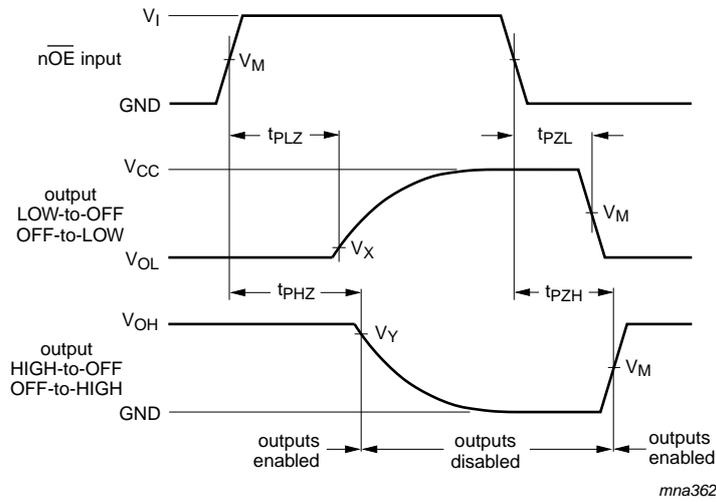


Measurement points are given in [Table 8](#).

The shaded areas indicate when the input is permitted to change for predictable performance.

V_{OL} and V_{OH} are the typical output voltage levels that occur with the output load.

Fig 8. Data set-up and hold times for the nDn input to the nCP input



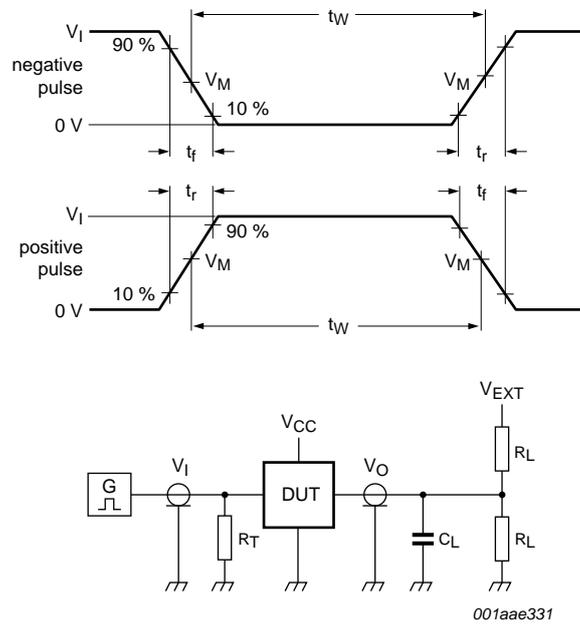
Measurement points are given in [Table 8](#).

V_{OL} and V_{OH} are the typical output voltage levels that occur with the output load.

Fig 9. 3-state enable and disable times

Table 8. Measurement points

| Supply voltage | Input | | Output | | |
|----------------|----------|---------------------|---------------------|--------------------------|--------------------------|
| V_{CC} | V_I | V_M | V_M | V_X | V_Y |
| 1.2 V | V_{CC} | $0.5 \times V_{CC}$ | $0.5 \times V_{CC}$ | $V_{OL} + 0.1 \text{ V}$ | $V_{OH} - 0.1 \text{ V}$ |
| 2.7 V | 2.7 V | 1.5 V | 1.5 V | $V_{OL} + 0.3 \text{ V}$ | $V_{OH} - 0.3 \text{ V}$ |
| 3.0 V to 3.6 V | 2.7 V | 1.5 V | 1.5 V | $V_{OL} + 0.3 \text{ V}$ | $V_{OH} - 0.3 \text{ V}$ |



Test data is given in [Table 9](#).

Definitions for test circuit:

R_L = Load resistance.

C_L = Load capacitance including jig and probe capacitance.

R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator.

V_{EXT} = External voltage for measuring switching times.

Fig 10. Test circuit for measuring switching times

Table 9. Test data

| Supply voltage | Input | | Load | | V_{EXT} | | |
|----------------|----------|---------------|-------|------------------|--------------------|--------------------|--------------------|
| | V_I | t_r, t_f | C_L | R_L | t_{PLH}, t_{PHL} | t_{PLZ}, t_{PZL} | t_{PHZ}, t_{PZH} |
| 1.2 V | V_{CC} | ≤ 2.5 ns | 50 pF | 500 Ω [1] | open | $2 \times V_{CC}$ | GND |
| 2.7 V | 2.7 V | ≤ 2.5 ns | 50 pF | 500 Ω | open | $2 \times V_{CC}$ | GND |
| 3.0 V to 3.6 V | 2.7 V | ≤ 2.5 ns | 50 pF | 500 Ω | open | $2 \times V_{CC}$ | GND |

[1] The circuit performs better when $R_L = 1$ k Ω .

12. Package outline

SSOP48: plastic shrink small outline package; 48 leads; body width 7.5 mm

SOT370-1

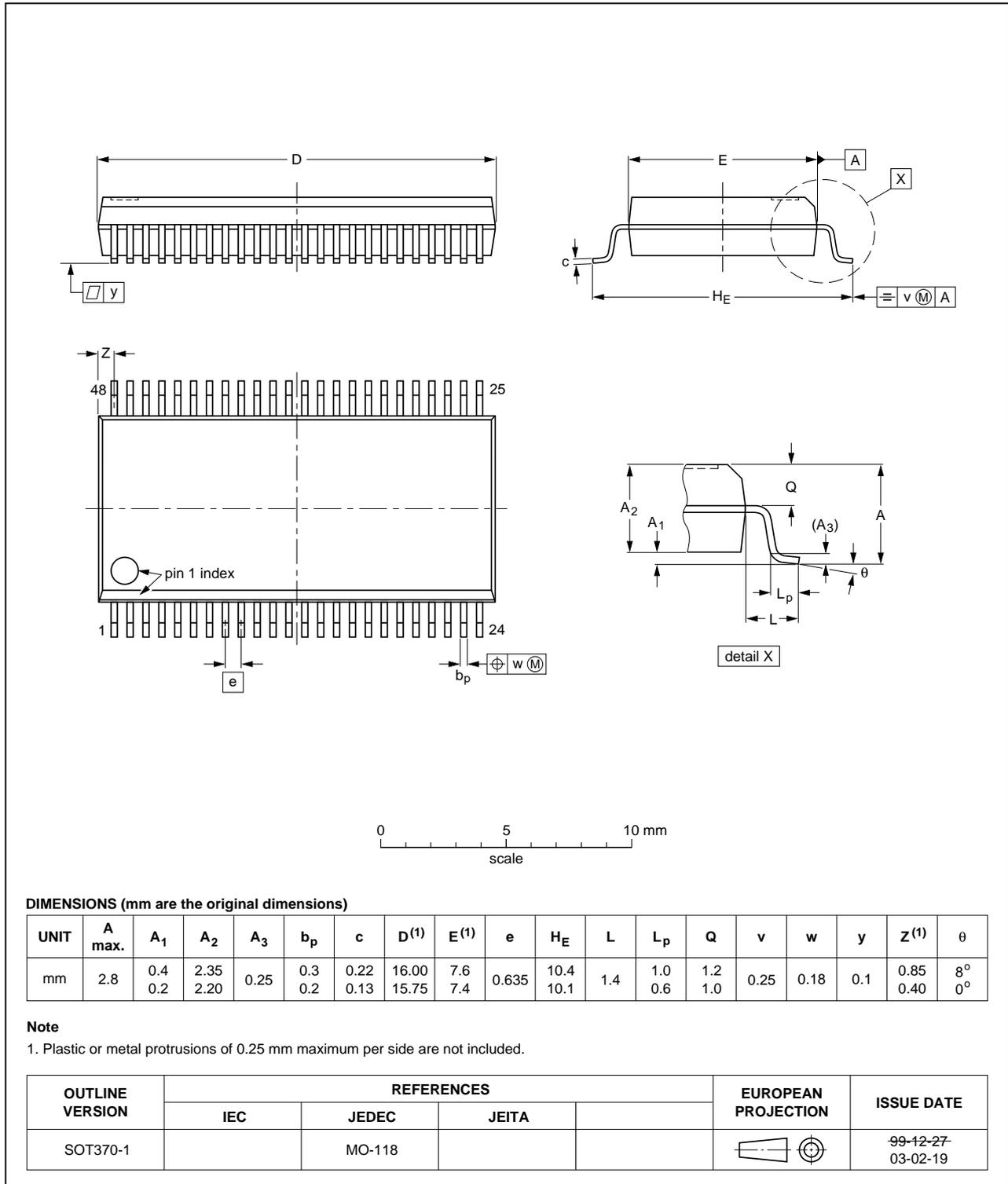


Fig 11. Package outline SOT370-1 (SSOP48)

TSSOP48: plastic thin shrink small outline package; 48 leads; body width 6.1 mm

SOT362-1

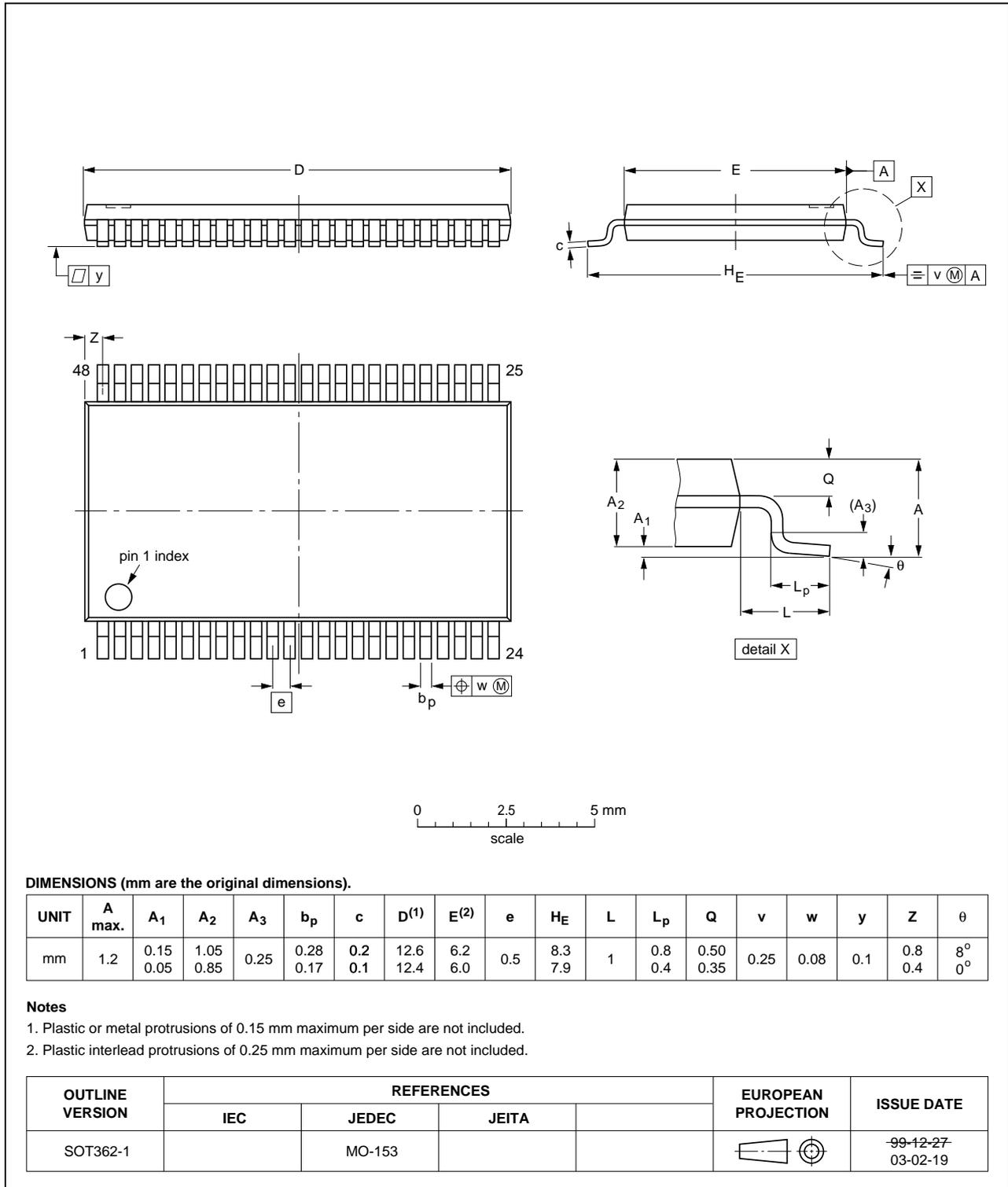


Fig 12. Package outline SOT362-1 (TSSOP48)

HXQFN60U: plastic thermal enhanced extremely thin quad flat package; no leads; 60 terminals; UTLP based; body 4 x 6 x 0.5 mm

SOT1134-1

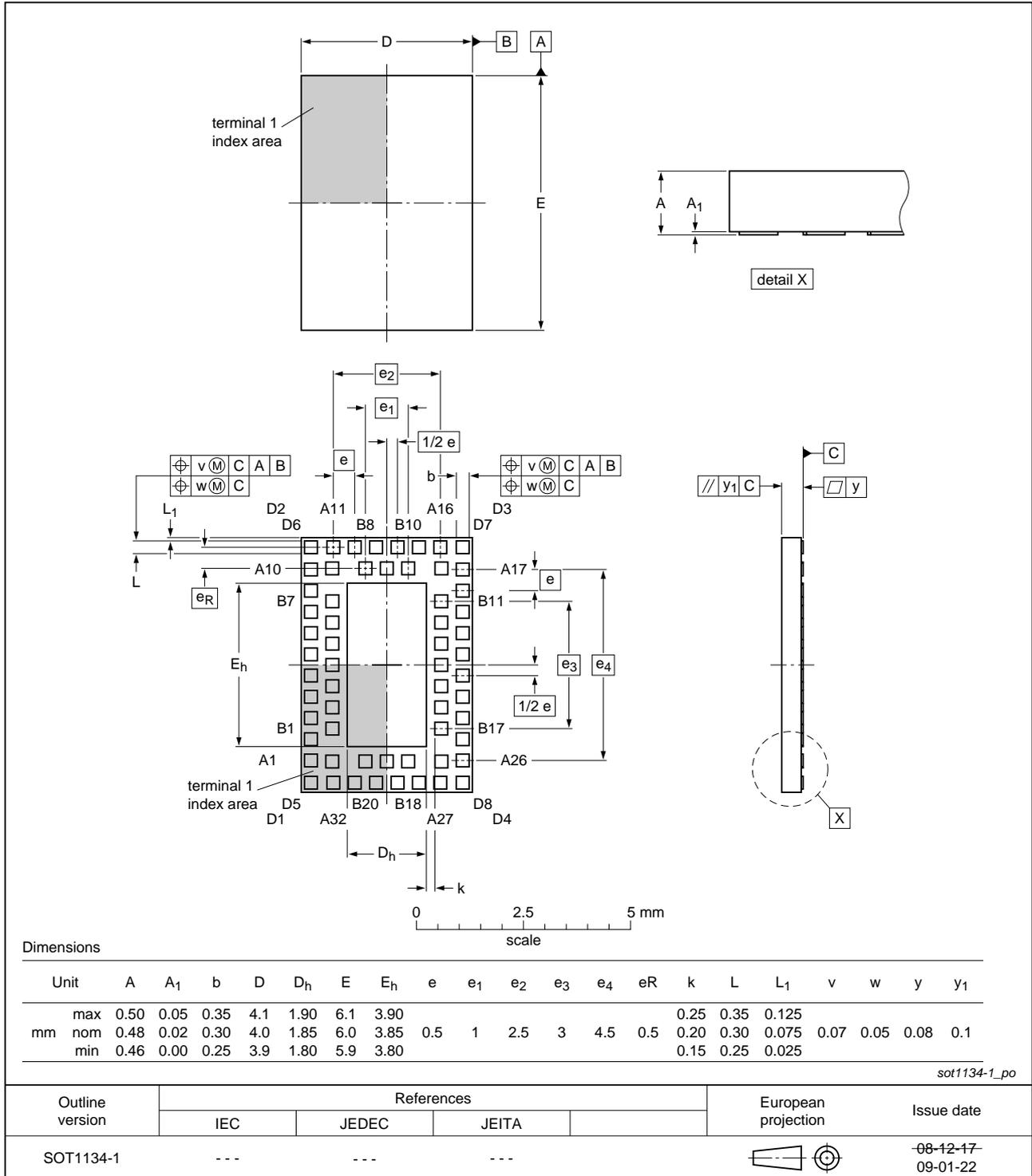


Fig 13. Package outline SOT1134-1 (HXQFN60U)

13. Abbreviations

Table 10. Abbreviations

| Acronym | Description |
|---------|-----------------------------|
| CDM | Charged Device Model |
| DUT | Device Under Test |
| ESD | ElectroStatic Discharge |
| HBM | Human Body Model |
| TTL | Transistor-Transistor Logic |

14. Revision history

Table 11. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|----------------------------------|---|-----------------------|---------------|----------------------------------|
| 74LVC_LVCH16374A v.8 | 20110621 | Product data sheet | - | 74LVC_LVCH16374A v.7 |
| Modifications: | <ul style="list-style-type: none"> Type numbers 74LVC16374ABQ and 74LVCH16374ABQ changed to 74LVC16374ABX and 74LVCH16374ABX. | | | |
| 74LVC_LVCH16374A v.7 | 20100323 | Product data sheet | - | 74LVC_LVCH16374A v.6 |
| Modifications: | <ul style="list-style-type: none"> 74LVC16374ABQ and 74LVCH16374ABQ changed from HUQFN60U (SOT1025-1) to HXQFN60U (SOT1134-1) package. | | | |
| 74LVC_LVCH16374A v.6 | 20090212 | Product data sheet | - | 74LVC_LVCH16374A v.5 |
| 74LVC_LVCH16374A v.5 | 20031212 | Product specification | - | 74LVC_H16374A v.4 |
| 74LVC_H16374A v.4 | 19980317 | Product specification | - | 74LVC16374A_ 74LVCH16374A v.3 |
| 74LVC16374A_ 74LVCH16374A v.3 | 19980317 | Product specification | - | 74LVC16374A v.2 |
| 74LVC16374A v.2 | 19970822 | Product specification | - | 74LVC16374A v.1 |
| 74LVC16374A v.1 | - | - | - | - |

15. Legal information

15.1 Data sheet status

| Document status ^{[1][2]} | Product status ^[3] | Definition |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nxp.com>.

15.2 Definitions

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